CuInS₂ thin films obtained through the annealing of chemically deposited In₂S₃–CuS thin films

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Keywords:
CuInS₂
Thin Films
Chemical bath deposition

A R T I C L E   I N F O
Article history:
Received 12 February 2010
Received in revised form 14 September 2010
Accepted 18 September 2010
Available online 25 September 2010

A B S T R A C T
In this work, we report the formation of CuInS₂ thin films on glass substrates by heating chemically deposited multilayers of copper sulfide (CuS) and indium sulfide (In₂S₃) at 300 and 350 °C in nitrogen atmosphere at 10 Torr. CIS thin films were prepared by varying the CuS layer thickness in the multilayers with indium sulfide. The XRD analysis showed that the crystallographic structure of the CuInS₂ (JCPDS 27-0159) is present on the deposited films. From the optical analysis it was estimated the band gap value for the CIS film (1.49 eV). The electrical conductivity varies from 3 × 10⁻⁸ to 3 × 10⁻¹ cm⁻¹ depending on the thickness of the CuS film. CIS films showed p-type conductivity.

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1. Introduction
Copper indium sulfide (CuInS₂) thin films are one of the most promising absorber materials in solar cells because of its high optical absorption coefficient (10⁵ cm⁻¹), and optimum optical band gap of 1.5 eV. This material has been incorporated in photovoltaic structures resulting in considerable conversion efficiencies [1,2]. Scheer et al. [1] showed an efficiency of 10.2% using CuInS₂, the device was prepared by depositing a cadmium sulfide layer as window material. Ellmer et al. [2] prepared CuInS₂ absorbers for thin film solar cells by using the reactive magnetron sputtering technique. After the first experiments a solar cell efficiency of 6.4% at AM1.5 was achieved.

Some authors have used the chemical bath deposition technique to deposit CuInS₂ thin films. Pathan and Lokhande [3] obtained CIS thin films by chemical method, the electrical resistivity of the films was of the order of 10 Ω cm, and showed p-type electrical conductivity. On the other hand, some authors have preferred other routes to grow CIS thin films, some of these are: spray pyrolysis [4,5], sputtering [6], one-stage RF reactive sputtering [7] and chemical bath deposition [8,9].

The main purpose of the present work is to deposit good quality CIS thin films using simple chemical bath deposition method. In this paper we report the results of CuInS₂ thin films through a process of multilayers deposited from indium sulfide (In₂S₃) and copper sulfide (CuS) films. These multilayers were annealed in nitrogen atmosphere.

2. Experimental details

2.1. Deposition of indium sulfide thin films
Chemically deposited indium sulfide thin films were obtained by following the procedure given in Ref. [10] using indium chloride (InCl₃, 99.99% Alfa Aesar) and thioacetamide (CH₃CSNH₂, 99.8%, Fisher Chemical) as precursor materials. The chemical bath was prepared as follows: 10 ml of InCl₃ 0.1 M, 20 ml of acetic acid 0.5 M (99.9% CTR Scientific) and 20 ml of thioacetamide 1 M was mixed and diluted to 100 ml with distilled water, the reagents were mixed by stirring. The glass substrates (Corning, 25 mm × 75 mm) were placed vertically in the solution at 25 °C for 60 h without stirring. The films obtained have a thickness of 0.3 μm.

2.2. Deposition of CuS thin films
The procedure given in Ref. [11] was followed to deposit copper sulfide thin films by using 5 ml of 0.5 M solution of CuCl₂·2H₂O (99%, Fisher Chemicals) mixed with 9 ml of 1 M solution of Na₂S₂O₃ (99.7%, Fermont), 10 ml of 0.5 M dimethylthiourea (99%, Aldrich), and the remainder with distilled water to complete 100 ml, the reagents were mixed by stirring. Indium sulfide thin films (0.3 μm) were used as substrates, and for the deposition the substrates were placed vertically in the solution at 70 °C for 1, 2, and 2.5 h without stirring. Multilayer films In₂S₃–CuS were deposited on both...
sides of the substrates. The thin film deposited on the side of the substrate facing the beaker wall was retained for the optical and electrical characterization. The coating on the other side was wiped off with dilute hydrochloric acid (HCl). The thickness obtained for films deposited for 1, 2 and 2.5 h was 0.22, 0.28, and 0.35 µm, respectively.

The multilayer films were annealed at 300 and 350 °C in nitrogen atmosphere for 30 min at 10 Torr to form the crystalline phase of CuInS2.

2.3. Characterization

XRD diffraction patterns were recorded on a Siemens D-500 X-ray diffractometer using Cu Kα radiation (λ = 1.5406 Å). Atomic force microscopy (AFM) analysis was done using JEOL Model JSPM-4210 equipment, the topography contrast images were acquired in the no contact mode. The optical transmittance at normal incidence spectra of the samples were measured with a spectrophotometer UV-3101PC region 1100–1900 nm wavelength range. For the electrical measurements current versus time data were recorded on a computerized system using a Keithley 6487 programmable voltage source. Pairs of coplanar silver print electrodes of 5 mm length at 5 mm separation were painted on the surface of the films. The samples were illuminated with a tungsten-halogen lamp, which provided an intensity of illumination of 350 W/m² at the plane of the sample. Current in the dark was recorded for 20 s followed by 20 s under illumination, and finally 20 s in the dark. Thickness of the films was measured using an Alpha Step model 100 profilometer from Tencor Instruments.

3. Results and discussion

3.1. Structural studies

Fig. 1 shows the X-ray diffraction (XRD) patterns of In2S3–CuS thin film of 0.22 µm, recorded after the films were annealed in N2 at (a) 300 °C and (b) 350 °C for 30 min at 10 Torr. The XRD pattern shown in Fig. 1(a) corresponds to CuInS2 (112), but also one additional peak due to an excess of sulfur (080) was identified. Fig. 1(b) shows the XRD pattern corresponding to CuInS2 (112), and additional peaks (220) and (312) corresponding to CuInS2 were identified.

Fig. 2 shows the X-ray diffraction (XRD) patterns of In2S3–CuS thin film of 0.28 µm, recorded after the films were annealed in N2 at (a) 300 °C and (b) 350 °C for 30 min at 10 Torr. In Fig. 2(a) there are not peaks corresponding to the CuInS2 compound, but there is a small peak (1 1 0) corresponding to the covellite phase (JCPDS 06-0464). Fig. 2(b) shows the XRD pattern corresponding to CuInS2 (112), (2 1 1), (2 2 0), and (3 1 2).

Fig. 3 shows the X-ray diffraction (XRD) patterns of In2S3–CuS thin film of 0.35 µm, recorded after the films were annealed in N2 at (a) 300 °C and (b) 350 °C for 30 min at 10 Torr. The XRD pattern shown in Fig. 3(a) corresponds to a mixture of phases: CuS (1 1 0) and (1 0 2), and CuInS2 (1 1 2) and (0 0 4). Fig. 3(b) shows the XRD pattern corresponding to CuInS2, there is an intense peak (1 1 2) at 2θ = 27.8° and other prominent peaks (2 0 4) at 46.5° and (3 1 2)
Fig. 4. AFM images of CuInS$_2$ (In$_2$S$_3$–CuS 0.35 μm) films obtained at 350 °C for 30 min, 10 Torr. (a) low magnifications, (b) high magnification, and (c) ellipsoidal nanoparticle with 28 nm of major axis (line 1) and 14 nm of minor axis (line 2).

at 54.8°, which are signatures of the chalcopyrite structure of CIS. The planes (1 1 2) and (2 0 4) of the CuInS$_2$ compound were used to estimate the grain size (11 nm).

3.2. Morphological analysis

Fig. 4 shows typical AFM images of the surface topography for the CuInS$_2$ thin film (In$_2$S$_3$–CuS 0.35 μm) after annealing in nitrogen for 30 min at 350 °C, showing that the small grains had coalesced because of the annealing temperature, resulting in a uniform surface with some additional big grains observed on the film surface. Fig. 4(a) shows agglomerates of approximately 100–150 nm and a homogenous deposit on the substrate surface. The root mean square (rms) value for films is 6.3 nm. Individual nanometric particles were also observed (see Fig. 4(b)). The CuInS$_2$ film possesses ellipsoidal nanoparticles with dimensions approaching 28 nm of major axis and 14 nm of minor axis (Fig. 4(c), line 1 and 2, respectively). This is in good agreement with the particle size estimated by X-ray diffraction (11 nm).

3.3. Optical characterization

Fig. 5 shows the optical transmittance spectra and absorption coefficient for the CuInS$_2$ (In$_2$S$_3$–CuS) films: (a) 0.28 μm and (b) 0.35 μm, after annealing in nitrogen performed for 30 min at 350 °C.

As we can see, the behavior of the transmittance spectra is different for films with different thickness of the CuS thin film. There is a shift in the absorption edge towards higher wavelengths for the thicker film. The band gap was calculated using the relationship:

$$ahv = A(hv - E_g)^n$$

where $A$ is a constant as a function of the transition probability and $E_g$ is the optical band gap. The $E_g$ values can be obtained from the best linear approximation of $(ahv)^2$ versus $hv$ plot, and its extrapolation to $(ahv)^2 = 0$ (see Fig. 6). The $E_g$ values obtained for the CuInS$_2$ (In$_2$S$_3$–CuS 0.35 μm) films after annealing in nitrogen at 300 and 350 °C for 30 min were 1.85 eV and 1.49 eV, respectively. The $E_g$ value of 1.49 eV for the CuInS$_2$ film obtained at 350 °C is close to the value reported for this material [12].

3.4. Electrical characterization

The electrical conductivity values obtained for CuInS$_2$ (In$_2$S$_3$–CuS: 0.22, 0.28, and 0.35 μm) films after annealing in nitrogen at 350 °C were: $10^{-8}$ Ω$^{-1}$ cm$^{-1}$ (0.22 μm), $10^{-5}$ Ω$^{-1}$ cm$^{-1}$ (0.28 μm), and 3 Ω$^{-1}$ cm$^{-1}$ (0.35 μm). CuInS$_2$ thin films showed p-type electrical conductivity.
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Fig. 6. Plot of $(\alpha h)/(\hbar T)$ versus $h/(\hbar T)$ for the CuInS$_2$ (In$_2$S$_3$–CuS 0.35 μm) films after annealing in nitrogen at 300 °C ($E_g = 1.85$ eV) and 350 °C ($E_g = 1.49$ eV) for 30 min.

4. Conclusions

CuInS$_2$ thin films can be prepared by annealing chemically deposited In$_2$S$_3$–CuS thin films at 350 °C in nitrogen atmosphere for 30 min. The AFM analysis revealed that these films have a homogeneous surface and grain sizes in the order of nanometers. The conductivity values for the films vary from $10^{-8}$ to $3\Omega^{-1}$ cm$^{-1}$, depending on the CuS film thickness in the multilayers. The optical band gap of 1.49 eV obtained for the CuInS$_2$ (In$_2$S$_3$–CuS, 0.35 μm) film suggests the use of this film in photovoltaic structures.

Acknowledgements

We are grateful to Maria Luisa Ramón for the XRD measurements (CIE-UNAM), José Ortega for technical support (CIE-UNAM), Dra. M.T.S. Nair and Dr. P.K. Nair (CIE-UNAM) for providing some experimental facilities. This research was supported by CONACyT (79179) and PROMEP/103.5/09/6639.

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